## SiRS4302DP

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**Vishay Siliconix** 



**PRODUCT SUMMARY** 30 V<sub>DS</sub> (V)  $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 10 V 0.00057  $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS}$  = 4.5 V 0.00083 Q<sub>g</sub> typ. (nC) 73

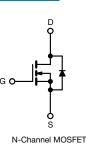
### **FEATURES**

N-Channel 30 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)
- 100 % R<sub>g</sub> and UIS tested
- Enhance power dissipation and lower R<sub>thJC</sub>
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Synchronous rectification
- DC/DC converters
- · OR-ing and hot swap switch
- Battery management



RoHS

COMPLIANT HALOGEN

FREE

I <sub>D</sub> (A) <sup>a</sup>	478	
Configuration	Single	
ORDERING INFORMAT	ΓΙΟΝ	
Package		

ORDERING INFORMATION	
Package	PowerPAK SO-8S
Lead (Pb)-free and halogen-free	SiRS4302DP-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, u	Inless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	v	
Gate-source voltage		V <sub>GS</sub>	+20, -16	v	
	T <sub>C</sub> = 25 °C		478		
Continuous drain ourrent (T 150 °C)	T <sub>C</sub> = 70 °C	1 .	382		
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	l <sub>D</sub>	87 <sup>b, c</sup>	1	
	T <sub>A</sub> = 70 °C	1	70 <sup>b, c</sup>		
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	600	A	
	T <sub>C</sub> = 25 °C		189	1	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	6.2 <sup>b, c</sup>	1	
Single pulse avalanche current		I <sub>AS</sub>	65	1	
Single pulse avalanche energy L = 0.1 mH		E <sub>AS</sub>	211	mJ	
	T <sub>C</sub> = 25 °C		208		
Maximum power dissipation	T <sub>C</sub> = 70 °C		133	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	6.9 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	4.4 b, c	1	
Operating junction and storage temperature	e range	TJ, Tstg	-55 to +150	*0	
Soldering recommendations (peak temperature) <sup>c</sup>		Ĭ	260	°C	

THERMAL RESISTANCE RATING	HERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b	t ≤ 10 s	R <sub>thJA</sub>	14	18	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.46	0.60	0/10	

Notes

a. T<sub>C</sub> = 25 °C b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 55 °C/W d.

e.

f.

S23-0400-Rev. B, 05-Jun-2023

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## SiRS4302DP



Vishay Siliconix

<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ , 0	CVMDOI	TEST CONDITIONS	MIN		MAY	11111	
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				1	1		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	$I_D = 10 \text{ mA}$	-	18.1	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.2	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	2.2	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = +20, -16 V$	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA	
	-055	$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	-	-	10		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00047	0.00057	0057 Ω	
	UDS(on)	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.00065	0.00083	52	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	140	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	10150	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	4325	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	300	-		
<b>-</b>		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	153	230		
Total gate charge	Qg		-	73	110		
Gate-source charge	Q <sub>qs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	30	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	17	-		
Output charge	Q <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	-	118	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz	0.24	1.2	2.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	16	30		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega, \text{ I}_{\text{D}} \cong 10 \text{ A},$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	65	130	1	
Fall time	t <sub>f</sub>		-	15	30	-	
Turn-on delay time	t <sub>d(on)</sub>		-	55	110	ns	
Rise time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	110	220	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	60	120	1	
Fall time	t <sub>f</sub>		-	30	60		
Drain-Source Body Diode Characterist	· · ·				•	I	
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	189		
Pulse diode forward current	I <sub>SM</sub>	5	-	-	600	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.70	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	75	150	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs,	_	80	160	nC	
Reverse recovery fall time	t <sub>a</sub>						
Reverse recovery rise time	t <sub>b</sub>	<b>~</b>		30		ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

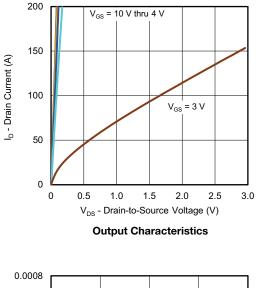
b. Guaranteed by design, not subject to production testing

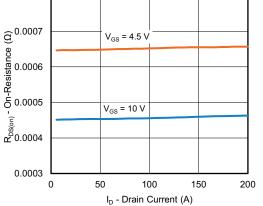
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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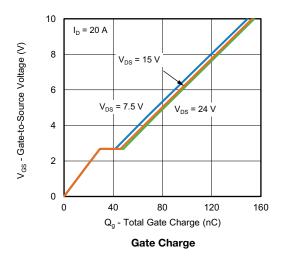


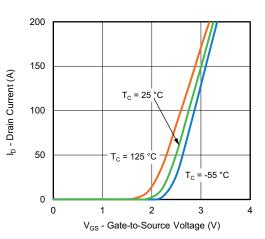
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



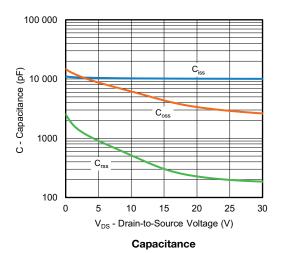


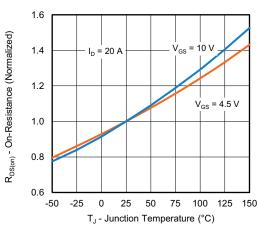
**On-Resistance vs. Drain Current and Gate Voltage** 





Transfer Characteristics





**On-Resistance vs. Junction Temperature** 

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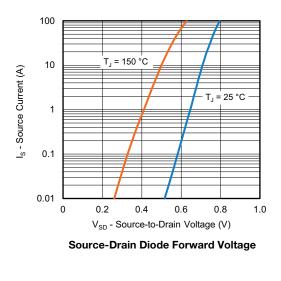
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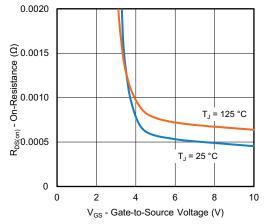
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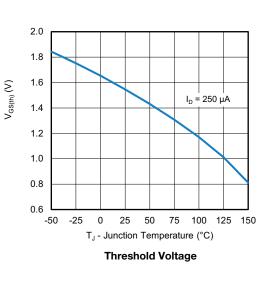


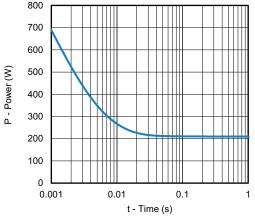
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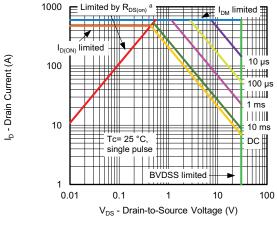


On-Resistance vs. Gate-to-Source Voltage





Single Pulse Power, Junction-to-Case



Safe Operating Area, Junction-to-Case

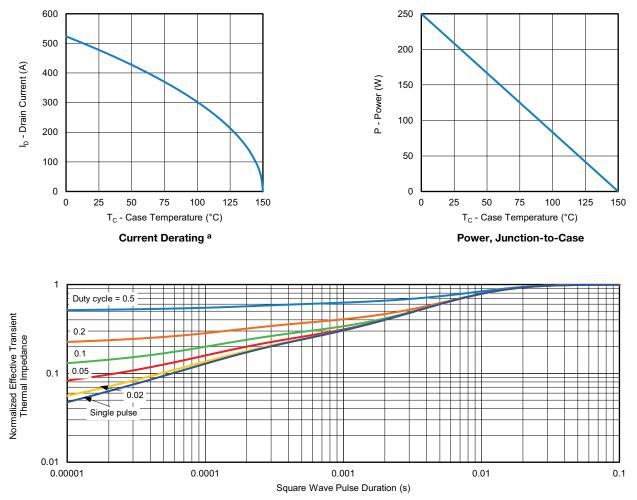
#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

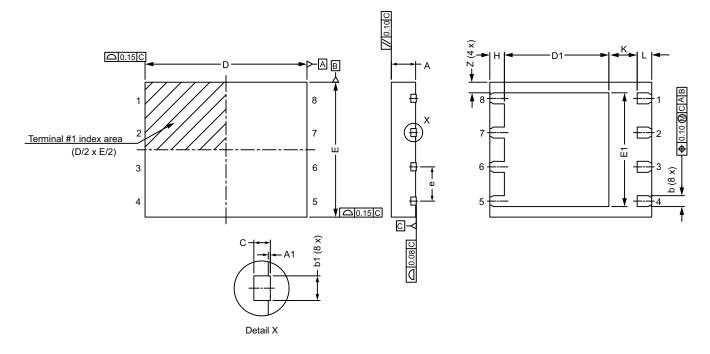
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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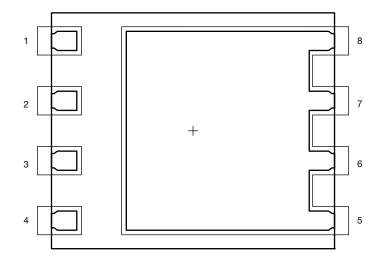
PowerPAK<sup>®</sup> SO-8S BWL

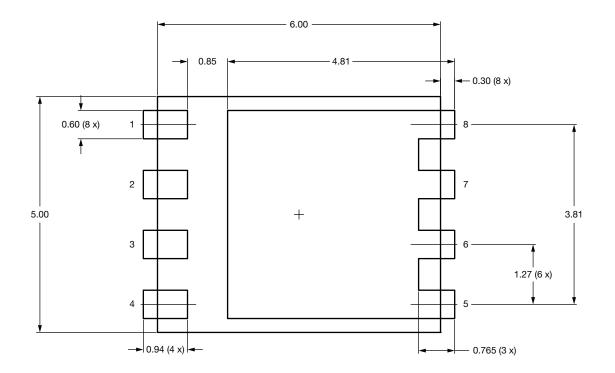


DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.85	0.90	0.95	0.033	0.035	0.037	
A1	-	-	0.05	-	-	0.002	
b	0.31	0.41	0.51	0.012	0.016	0.020	
b1	0.20	0.30	0.40	0.008	0.012	0.016	
С		0.20 ref.	•		0.008 ref.		
D	5.90	6.00	6.10	0.232	0.236	0.240	
D1	3.78	3.88	3.98	0.149	0.153	0.157	
E	4.90	5.00	5.10	0.193	0.197	0.201	
E1	4.12	4.22	4.32	0.162	0.166	0.170	
е	1.27 BSC 0.050		0.050 BSC				
Н	0.44	0.54	0.64	0.017	0.021	0.025	
К		1.05 ref.	•	0.041 ref.			
L	0.44	0.54	0.64	0.017	0.021	0.025	
Z		0.39 ref.		0.015 ref.			
N: C20-0936-Rev. A, /G: 6082	03-Aug-2020						



# **Recommended Land Pattern PowerPAK® SO-8S BWL**





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